

SOT109-2

plastic small outline package; 16 leads; body width 3.9 mm; low stand-off height

8 February 2016

Package information

1. Package summary

Terminal position code D (double)

Package type descriptive code SO16

Package type industry code SO16

Package style descriptive codeSO (small outline)Package style suffix codeNA (not applicable)

Package body material type P (plastic)

IEC package outline code 076E07

JEDEC package outline code MS-012

Mounting method type S (surface mount)

Issue date 19-2-2003

Table 1. Package summary

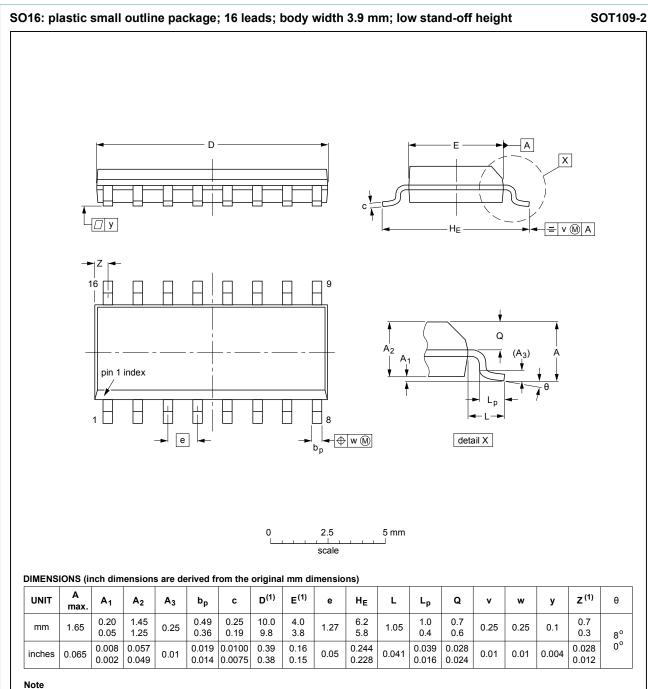
Symbol	Parameter	Min	Тур	Nom	Max	Unit
D	package length	9.8	-	9.9	10	mm
E	package width	3.8	-	3.9	4	mm
Α	seated height	[tbd]	-	1.65	1.65	mm
A ₂	package height	1.25	-	1.35	1.45	mm
е	nominal pitch	-	-	1.27	-	mm
n ₂	actual quantity of termination	-	-	16	-	



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2. Package outline



1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT109-2	076E07	MS-012				-99-12-27 03-02-19	

Fig. 1. Package outline SO16 (SOT109-2)

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3. Legal information

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